#### S/N 09/866,938

IN THE UNITED STATES PATERS AND TRADEMARK OFFICE

DEC 1 0 2001

Applicant:

Wendell P. Noble et al.

Serial No.:

09/866,938

Filed:

May 29, 2001

Title:

ULTRA HIGH DENSITY FRASH MEN

Examiner:

Group Art Unit: 2813

Docket: 303.330US3

### SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents Washington, D.C. 20231

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants further request that a copy of the 1449 form, initialled by the Examiner to indicate that all listed citations have been considered, be returned with the next official communication.

Under 37 C.F.R. §1.97(b)(3), it is believed that no fee or certificate is required with this Information Disclosure Statement. However, if an Office Action on the merits has been mailed; the Commissioner is hereby authorized to charge any additional fees or credit any overpayment to Account No. 19-0743.

The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Respectfully submitted,

WENDELL P. NOBLE ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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Edward J. Brooks, III

Reg. No. 40,925

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents, Washington, D.C. 20231, on this day of November 2001

Gina M. Uphus

Signatur

RECEIVE

Name



Sheet 1 of 1

Form 1449\*

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use several sheets if necessary)

Atty. Docket No.: 303.330US3

Serial No. 09/866,938

Applicant: Wendell P. Noble et al.

Filing Date: May 29, 2001

Group: 2813

#### U.S. PATENT DOCUMENTS

**Examiner Initial	Document Number	Date	Name Class	Subclass	Filing Date If Appropriate
				· · · <u>-</u>	
	_ 4,252,579	02/24/1981	Ho, I.T., et al. 148	174	05/07/79
	_ 4,929,988	05/29/1990	Yoshikawa, K. 357	23.5	08/23/88
	_ 5,874,760	02/23/1999	Burns, Jr., S.M., et al.257	315	01/22/97
	_ 5,943,267	08/24/1999	Sekariapuram, S., et al.365	185.28	06/12/98
	_ 6,172,391	01/09/2001	Goebel, B. 257	305	08/27/98
	_ 6,221,788	04/24/2001	Kobayashi, H., et al. 438	762	12/18/98
	_ 6,255,708	07/03/2001	Sudharsanan, R., et al. 257	428	10/10/97

#### FOREIGN PATENT DOCUMENTS

**Examiner							Translation
	Initial	Document Number	Date	Country	Class	Subclass	Yes   No
		2000-164883	06/16/2000	Japan	H01	L 29/786	

#### OTHER DOCUMENTS

\*\*Examiner Initial (Including Author, Title, Date, Pertinent Pages, Etc.)

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UEC 13 2001

Examiner

|Date Considered

\*Substitute Disclosure Statement Form (PTO-1449)

<u>S/N 09/866,938</u> <u>PATENT</u>

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

DEC 1 0 2001

Applicant:

Wendell P. Noble et al.

Serial No.:

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Filed:

May 29, 2001

Title:

ULTRA HIGH DENSITY FEASH MEMORY

Examiner:

Group Art Unit: 2813

Docket: 303.330US3

## **COMMUNICATION CONCERNING CO-PENDING APPLICATION(S)**

Applicant would like to bring to the Examiner's attention the following related co-

Commissioner for Patents Washington, D.C. 20231

Topping the state of the property of the state of the sta					
pending application(s) in the above-identified patent application:  Serial No. Filing Date Attorney Docket Title					
<u>Serial No.</u> 09/527,981	Filing Date 03/17/2000	Attorney Docket 00303.322US2	Title FOUR F2 FOLDED BIT LINE DRAM CELL STRUCTURE HAVING BURIED BIT AND WORD LINES		
09/571,352	05/16/2000	00303.322US3	FOUR F2 FOLDED BIT LINE DRAM CELL STRUCTURE HAVING BURIED BIT AND WORD LINES		
09/510,095	02/22/2000	00303.323US2	SEMICONDUCTOR-ON-INSULATOR MEMORY CELL WITH BURIED WORD AND BODY LINES		
09/139,164	08/24/1998	00303.328US2	MEMORY CELL HAVING A VERTICAL TRANSISTOR WITH BURIED SOURCE/DRAIN AND DUAL GATES		
09/596,266	06/16/2000	00303.328US3	MEMORY CELL HAVING A VERTICAL TRANSISTOR WITH BURIED SOURCE/DRAIN AND DUAL GATES		
09/651,199	08/30/2000	00303.328US4	MEMORY CELL HAVING A VERTICAL TRANSISTOR WITH BURIED SOURCE/DRAIN AND DUAL GATES		
09/789,274	02/20/2001	00303.329US4	MEMORY CELL WITH VERTICAL TRANSISTOR AND BURIED WORD AND BODY LINES		

# COMMUNICATION CONCERNING CO-PENDING APPLICATIONS Serial Number: 09/866,938 Filing Date: May 29, 2001 Title: ULTRA HIGH DENSITY FLASH MEMORY

Page 2 Dkt: 303.330US3

09/551,027	04/17/2000	00303.379US2	CIRCUIT AND METHOD FOR A FOLDED BIT LINE MEMORY CELL WITH VERTICAL TRANSISTOR AND TRENCH CAPACITOR
08/944,890	10/06/1997	00303.380US1	CIRCUIT AND METHOD FOR AN OPEN BIT LINE MEMORY CELL WITH A VERTICAL TRANSISTOR AND TRENCH PLATE TRENCH CAPACITOR
09/730,245	12/05/2000	00303.380US3	CIRCUIT AND METHOD FOR AN OPEN BIT LINE MEMORY CELL WITH A VERTICAL TRANSISTOR AND TRENCH PLATE TRENCH CAPACITOR
09/467,992	12/20/1999	00303.389US2	CIRCUITS WITH A TRENCH CAPACITOR HAVING MICRO-ROUGHENED SEMICONDUCTOR SURFACES
09/742,568	12/20/2000	00303.393US3	CIRCUIT AND METHOD FOR AN OPEN BIT LINE MEMORY CELL WITH A VERTICAL TRANSISTOR AND TRENCH PLATE TRENCH CAPACITOR
09/669,281	09/26/2000	00303.405US3	PROGRAMMABLE MEMORY ADDRESS DECODE ARRAYS WITH VERTICAL TRANSISTOR
09/520,494	03/08/2000	00303.406US2	FIELD PROGRAMMABLE LOGIC ARRAYS WITH VERTICAL TRANSISTORS
09/756,089	01/08/2001	00303.407US2	PROGRAMMABLE LOGIC ARRAY WITH VERTICAL TRANSISTORS
09/756,099	01/08/2001	00303.407US3	PROGRAMMABLE LOGIC ARRAY WITH VERTICAL TRANSISTORS
09/650,600	08/30/2000	00303.408US2	MEMORY ADDRESS DECODE ARRAY WITH VERTICAL TRANSISTORS
09/879,592	06/12/2001	00303.412US2	VERTICAL GAIN CELL AND ARRAY FOR A DYNAMIC RANDOM ACCESS

#### COMMUNICATION CONCERNING CO-PENDING APPLICATIONS

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Page 3 Dkt: 303.330US3

Serial Number: 09/866,938 Filing Date: May 29, 2001

Title: ULTRA HIGH DENSITY FLASH MEMORY

MEMORY AND METHOD FOR FORMING THE SAME

09/879,602 06/12/2001 00303.412US3

VERTICAL GAIN CELL AND ARRAY FOR A DYNAMIC RANDOM ACCESS

MEMORY AND METHOD FOR

FORMING THE SAME

09/498,433 02/04/2000 00303.464US2

CIRCUITS AND METHODS FOR A
MEMORY CELL WITH A TRENCH
PLATE TRENCH CAPACITOR AND A
VERTICAL BIPOLAR READ DEVICE

Respectfully submitted,

WENDELL P. NOBLE ET AL.

By Applicant's Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

P.O. Box 2938

Minneapolis, MN 55402

(612) 373-6913

Date

Edward J. Brooks, IIL

Reg. No. 40,925

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents, Washington, D.C. 20231, on this day of November, 2001.

Gina M Uphus

Name

Signature